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MP-2823

PTO/SB/21 (12/97) Approved for use through 9/30/2000. PMB 0651-0031
Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control pumbers 09/475,104 Application No. TRANSMITTAL FORM December 30, 4999 Filing Date (to be used for all correspondence after initial filing) First Named Inventor Nagesh Vodrahalli R 2800 Group Art Unit 2823 Deven M. Collins Examiner Name Total Number of Pages in This Submission 13 Attorney Docket Number 42390P6785 **ENCLOSURES** (check all that apply) After Allowance Communication to Group Assignment Papers (for an Application) Fee Transmittal Form Appeal Communication to Board of Appeals and Interferences Fee Attached Drawing(s) Appeal Communication to Group Amendment / Response Licensing-related Papers (Appeal Notice, Brief, Reply Brief) After Final Petition Routing Slip (PTO/SB/69) and Accompanying Petition Proprietary Information Affidavits/declaration(s) Status Letter To Convert a Provisional Application Extension of Time Request Additional Enclosure(s) Power of Attorney, Revocation Change of Correspondence Address (please identify below): Express Abandonment Request Terminal Disclaimer Information Disclosure Statement Small Entity Statement Certified Copy of Priority Document(s) Response to Missing Parts/ Incomplete Application Request for Refund Remarks Response to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT Firm William W. Schaal, Reg. No. 39,018 Individual name &ÓKOLOFF, TAYLOR & ZAFMAN LLP Signature Date 24-01 CERTIFICATE OF MAILING/TRANSMISSION I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class mail with sufficient postage in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on: September 24, 2001 Typed or printed name Laura R. Robles

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Date

September 24, 2001

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FEE TRANSMITTAL for FY 2000

Patent fees are subject to annual revision.

TOTAL AMOUNT OF PAYMENT (\$) 0.00

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	Complete if Known
Application No.	09/475,104
Filing Date	December 30, 1999 28
First Named Inventor	Nagesh Vodrahalli
Examiner Name	Deven M. Collins CENTER
Group/Art Unit	2823 ***********************************
Attorney Docket No.	42390P6785

Date

09/24/01

METHOD OF PAYMENT (check one)			FEE CALCULATION (continued)							
The Commissioner is hereby authorized to charge indicated fees and credit any overpayments to:		3. ADDITIONAL FEE								
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SUBMITTED BY Complete (if applicable)										
Name (PrintType) William W. Schaal			Registration No. 20 019 Talanham (714) 5					(714) 557		
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Docket No.: 42390P6785/

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE SEP 28 2001

In re Application of:

Vodrahalli, et al.

Application No.: 09/475,104

Filed: December 30, 1999

High Performance Thermal Interface For:

Curing Process for Organic Flip Chip

Packages

Examiner: Deven M. Collins

Art Group: 2823

AMENDMENT AND RESPONSE TO THE OFFICE ACTION

Assistant Commissioner for Patents Washington, DC 20231-9998

Sir:

Al

In response to the outstanding Office Action, mailed July 05, 2001, please amend the above-identified Application as follows:

IN THE SPECIFICATION

Please amend the Specification as follows:

Please replace the paragraph beginning at page 6, line 16 with the paragraph below:

As shown in Fig. 2b the thermal element 24 is placed onto the thermal epoxy 22 and the epoxy 22 is cured by a microwave generator 28. The microwave generator 28 generates energy at a microwave frequency that is directed into the thermal epoxy 22. The microwave frequency can be selected to cure the thermal epoxy 22 without damaging the integrated circuit 12 or heating the other components of the package 10. Not heating the other package components eliminates package warpage and epoxy pumping that can create air gaps and